

Product Summary

Device	BV _{DSS}	Rds(on) Max	I _D Max T _A = +25°C
		0.99Ω @ V _{GS} = 4.5V	0.5A
Q1	201/	1.2Ω @ V _{GS} = 2.5V	0.45A
QT	20V	1.8Ω @ V _{GS} = 1.8V	0.37A
		2.4Ω @ V _{GS} = 1.5V	0.32A
	-20V	1.9Ω @ V _{GS} = -4.5V	-0.36A
00		2.4Ω @ V _{GS} = -2.5V	-0.32A
Q2		3.4Ω @ V _{GS} = -1.8V	-0.27A
		5.0Ω @ V _{GS} = -1.5V	-0.22A

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

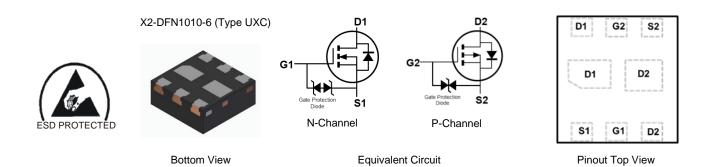
- Power-management functions
- Backlighting
- Load switches

Features

- Low On-Resistance
 - Very Low Gate Threshold Voltage
 - N-Channel: 1.0V Maximum
 - P-Channel: -1.0V Maximum
- Low Input/Output Leakage
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Package: X2-DFN1010-6
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish NiPdAu over Copper Leadframe; Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.0015 grams (Approximate)



Ordering Information (Note 4)

Orderable Part Number	Package	Tape Width (mm)	Tape Pitch (mm)	Packing		
	Fackage		Tape Fitch (min)	Qty.	Carrier	
DMC2991UDR4-7	X2-DFN1010-6 (Type UXC)	8	4	5000	Tape & Reel	

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

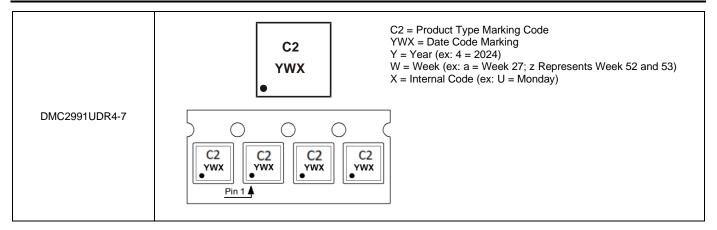
2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Haloger- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



Date Code Key

Year	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	2	3	4	5	6	7	8	9	0	1	2	3
Week		1-26				27-52			53			
Code	A-Z a-z			a-z					:	Z		
Internal Code	Sur	n l	Mon		Tue	W	ed	Thu		Fri		Sat
Code	Т		U		V	V	N	Х		Y		Z



Maximum Ratings Q1 N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	Vdss	20	V		
Gate-Source Voltage	Vgss	±8	V		
Continuous Drain Current (Note 5) $V_{GS} = 4.5V$	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	0.5 0.4	A
Maximum Continuous Body Diode Forward Current (Note 5)			ls	0.3	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			Ідм	1.4	A

Maximum Ratings Q2 P-CHANNEL (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	Vdss	-20	V		
Gate-Source Voltage	V _{GSS}	±8	V		
Continuous Drain Current (Note 5) $V_{GS} = -4.5V$	Steady State	T _A = +25°C T _A = +70°C	ID	-0.36 -0.3	A
Maximum Continuous Body Diode Forward Current (Note 5)			ls	-0.3	A
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			ldм	-0.8	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	0.37	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	337	°C/W
Total Power Dissipation (Note 6)		PD	0.7	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{0JA}	178	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

 Notes:
 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



DMC2991UDR4

Electrical Characteristics Q1 N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)				•		
Drain-Source Breakdown Voltage	BVDSS	20	—	_	V	$V_{GS} = 0V$, $I_D = 10\mu A$
Zero Gate Voltage Drain Current @Tc = +25°C	IDSS	_	_	1	μA	$V_{DS} = 16V, V_{GS} = 0V$
Gate-Source Leakage	lgss		—	±10	μA	$V_{GS} = \pm 5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(th)	0.4	—	1.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
			0.5	0.99		$V_{GS} = 4.5V, I_D = 100mA$
Static Drain-Source On-Resistance	Descer		0.6	1.2	Ω	$V_{GS} = 2.5V, I_D = 50mA$
Static Drain-Source On-Resistance	Rds(on)		0.7	1.8		V _{GS} = 1.8V, I _D = 20mA
			0.9	2.4		V _{GS} = 1.5V, I _D = 10mA
Diode Forward Voltage	V _{SD}	_	0.8	1.0	V	$V_{GS} = 0V, I_{S} = 150mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss		14.6			
Output Capacitance	Coss		4.7		pF	$V_{DS} = 16V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	Crss		3.2			1 - 1.00012
Total Gate Charge	Qg		0.28			
Gate-Source Charge	Qgs	_	0.04		nC	$V_{GS} = 4.5V, V_{DS} = 10V$ ID = 250mA
Gate-Drain Charge	Q_{gd}	_	0.1	_		ID = 230IIIA
Turn-On Delay Time	td(on)		7.1	_		
Turn-On Rise Time	tR		18	_		$V_{DD} = 10V, V_{GS} = 4.5V$
Turn-Off Delay Time	tD(OFF)	_	125	_	ns	$R_L = 47\Omega$, $R_G = 10\Omega$ $I_D = 200 \text{mA}$
Turn-Off Fall Time	tF		56.9			

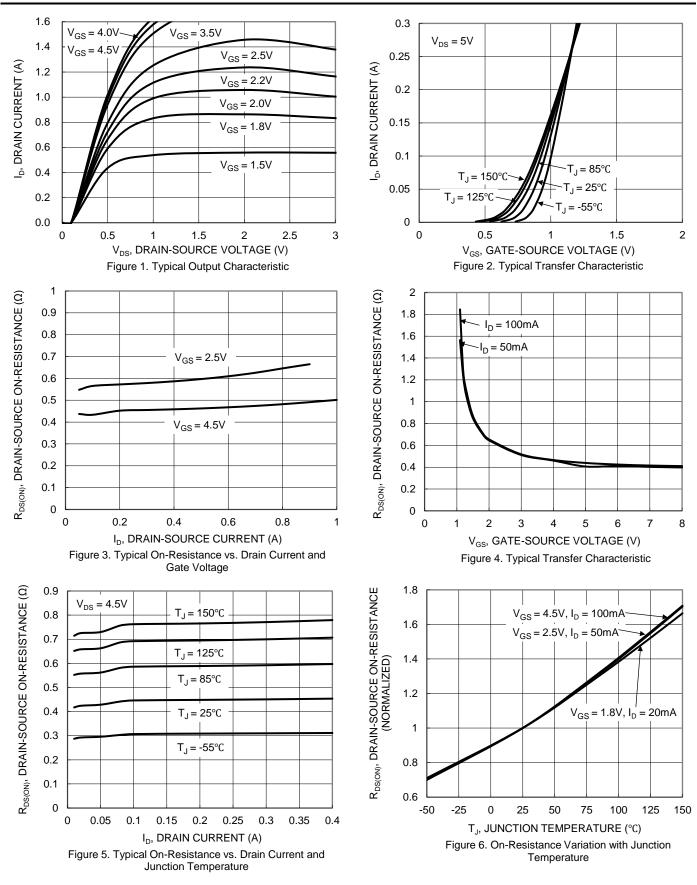
Electrical Characteristics Q2 P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)					•	·	
Drain-Source Breakdown Voltage	BVDSS	-20		_	V	V _{GS} = 0V, I _D = -250µA	
Zero Gate Voltage Drain Current $@T_C = +25^{\circ}C$	I _{DSS}	_	_	-1	μA	$V_{DS} = -16V, V_{GS} = 0V$	
Gate-Source Leakage	lgss	_	_	±10	μA	$V_{GS} = \pm 5V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	VGS(TH)	-0.4	_	-1.0	V	$V_{DS} = V_{GS}$, $I_D = -250 \mu A$	
		_	1.7	1.9		$V_{GS} = -4.5V, I_D = -100mA$	
Static Drain-Source On-Resistance	Descent		2.2	2.4	Ω	$V_{GS} = -2.5V, I_D = -50mA$	
Static Drain-Source On-Resistance	Rds(on)		2.9	3.4		$V_{GS} = -1.8V, I_D = -20mA$	
			3.7	5.0		$V_{GS} = -1.5V, I_D = -10mA$	
Diode Forward Voltage	Vsd		-0.7	-1.1	V	$V_{GS} = 0V$, $I_{S} = -10mA$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss		17	—			
Output Capacitance	Coss	_	4.1	_	pF	Vps = -16V, Vgs = 0V f = 1.0MHz	
Reverse Transfer Capacitance	Crss		2.7	—		1 - 1.00012	
Total Gate Charge	Qg		0.3	_			
Gate-Source Charge	Q _{gs}		0.04	—	nC	VGS = -4.5V, VDS = -10V ID = -250mA	
Gate-Drain Charge	Q _{gd}	_	0.1	_			
Turn-On Delay Time	td(on)	_	7.3	_			
Turn-On Rise Time	tR	_	20.7	_		V _{DD} = -15V, V _{GS} = -4.5V	
Turn-Off Delay Time	td(off)	_	185	—	ns	$R_G = 2\Omega$, $I_D = -200 mA$	
Turn-Off Fall Time	tF		97	_]		

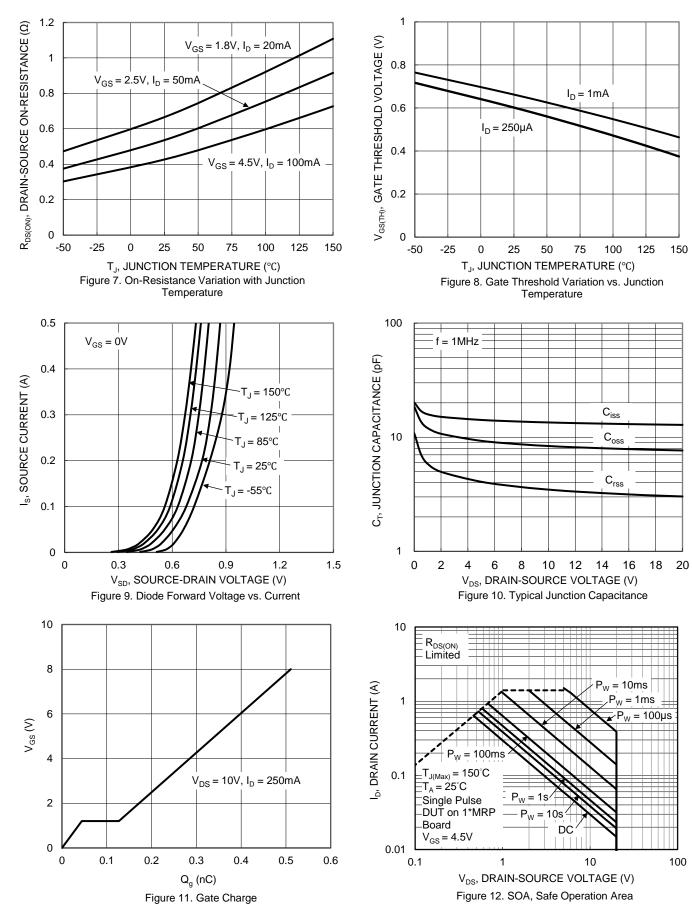
Notes: 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to production testing.



Q1 N-CHANNEL

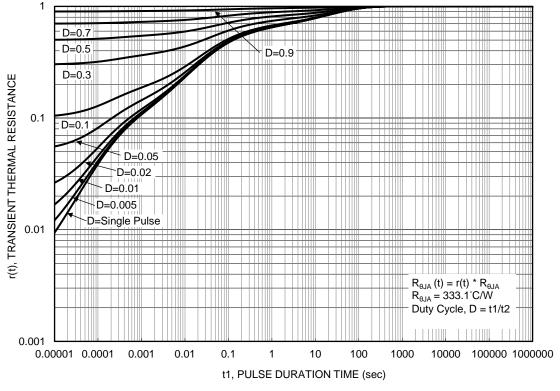








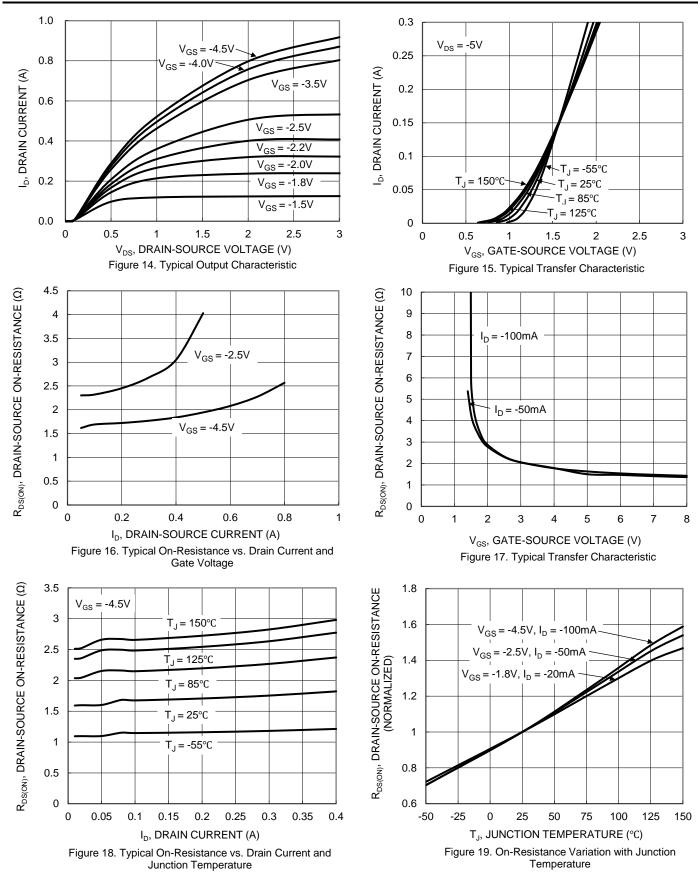






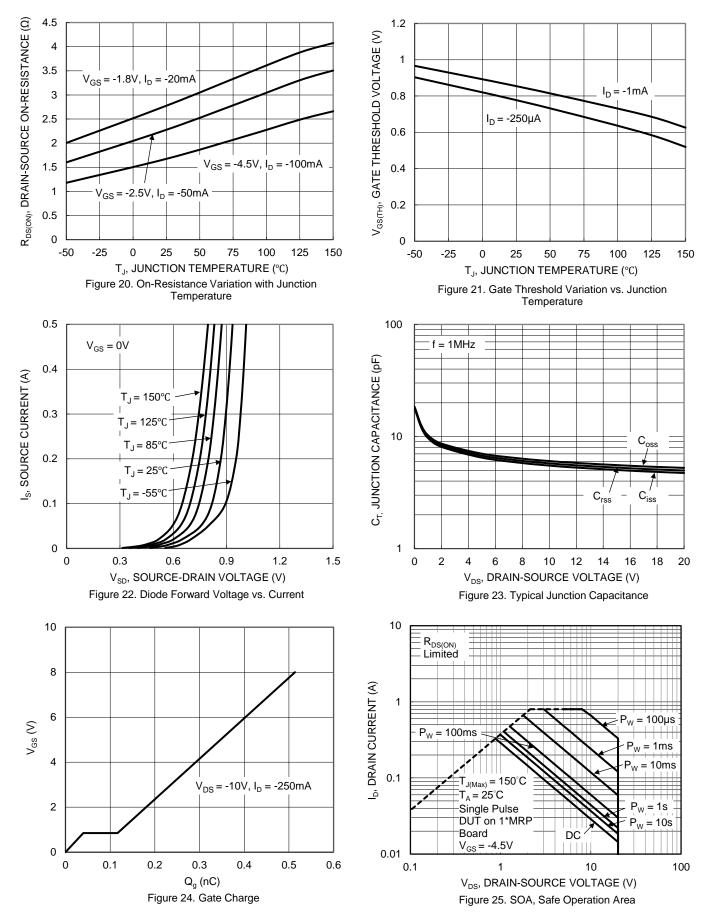


Q2 P-CHANNEL



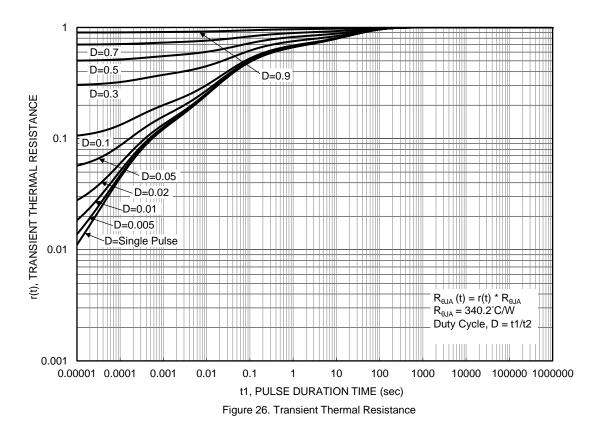


DMC2991UDR4





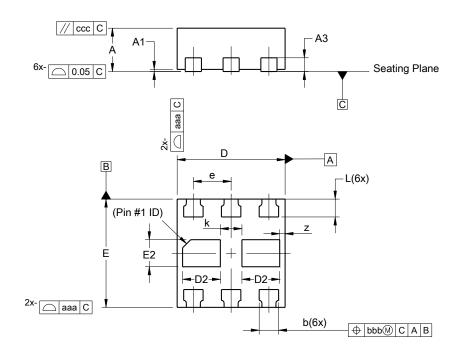






Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



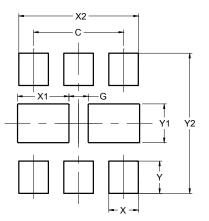
	X2-DFN (Type					
Dim	Min	Max	Тур			
A		0.40	0.39			
A1		0.05				
A3			0.127			
b	0.13	0.23	0.18			
D	0.95	1.05	1.00			
D2	0.30	0.40	0.35			
Е	0.95	1.05	1.00			
E2	0.20	0.30	0.25			
е	0.	350 BS	С			
L	0.115	0.215	0.165			
k			0.20			
z	0.02	0.08	0.05			
aaa	0.08					
bbb	0.07					
CCC		0.05				
All	Dimensi	ions in	mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN1010-6 (Type UXC)

X2-DFN1010-6 (Type UXC)



Dimensions	Value (in mm)
С	0.700
G	0.300
Х	0.230
X1	0.450
X2	0.930
Y	0.250
Y1	0.300
Y2	1.085



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